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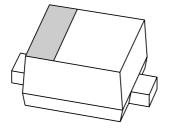
If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

## DISCRETE SEMICONDUCTORS

# DATA SHEET



## BAS716 Low-leakage diode

Product data sheet 2003 Nov 07



## Low-leakage diode

**BAS716** 

#### **FEATURES**

- Plastic SMD package
- Low leakage current: typ. 0.2 nA
- Switching time: typ. 0.6 μs
- Continuous reverse voltage: max. 75 V
- Repetitive peak reverse voltage: max. 85 V
- Repetitive peak forward current: max. 500 mA.

#### **APPLICATION**

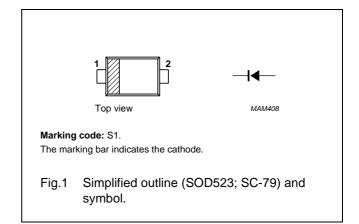
Low leakage current applications in surface mounted circuits.

#### **DESCRIPTION**

Epitaxial medium-speed switching diode with a low leakage current in an ultra small SOD523 (SC-79) SMD plastic package.

#### **PINNING**

PIN DESCRIPTION	
1	cathode
2	anode



#### **ORDERING INFORMATION**

TYPE NUMBER	PACKAGE			
ITPE NUMBER	NAME	DESCRIPTION	VERSION	
BAS716	_	plastic surface mounted package; 2 leads	SOD523	

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{RRM}$	repetitive peak reverse voltage		_	85	V
V <sub>R</sub>	continuous reverse voltage		_	75	V
IF	continuous forward current	see Fig.2; note 1	_	200	mA
I <sub>FRM</sub>	repetitive peak forward current		_	500	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave; $T_j = 25$ °C prior to surge; see Fig.4			
		t <sub>p</sub> = 1 μs	_	4	Α
		t <sub>p</sub> = 1 ms	_	1	Α
		t <sub>p</sub> = 1 s	_	0.5	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; note 1	_	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C

#### Note

1. Device mounted on a FR4 printed-circuit board.

## Low-leakage diode

**BAS716** 

#### **ELECTRICAL CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 mA	0.77	0.9	V
		I <sub>F</sub> = 10 mA	0.85	1	V
		I <sub>F</sub> = 50 mA	0.92	1.1	V
		I <sub>F</sub> = 150 mA	1.02	1.25	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 75 V	0.2	5	nA
		$V_R = 75 \text{ V}; T_j = 150 ^{\circ}\text{C}$	3	80	nA
		V <sub>R</sub> = 100 V	0.3	_	nA
$C_d$	diode capacitance	$V_R = 0 V$ ; $f = 1 MHz$ ; see Fig.6	2	_	pF
t <sub>rr</sub>	reverse recovery time	when switched from $I_F$ = 10 mA to $I_R$ = 10 mA; $R_L$ = 100 $\Omega$ ; measured at $I_R$ = 1 mA	0.6	3	μs

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	450	K/W
R <sub>th j-s</sub>	thermal resistance from junction to soldering point	note 2	120	K/W

#### **Notes**

1. Device mounted on a FR4 printed-circuit board. Refer to SOD523 (SC-79) standard mounting conditions.

2. Soldering point of the cathode tab.

## Low-leakage diode

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#### **GRAPHICAL DATA**

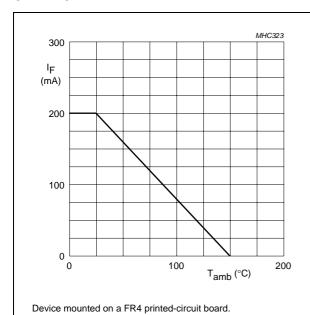
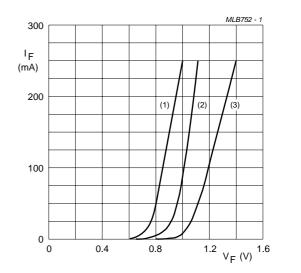
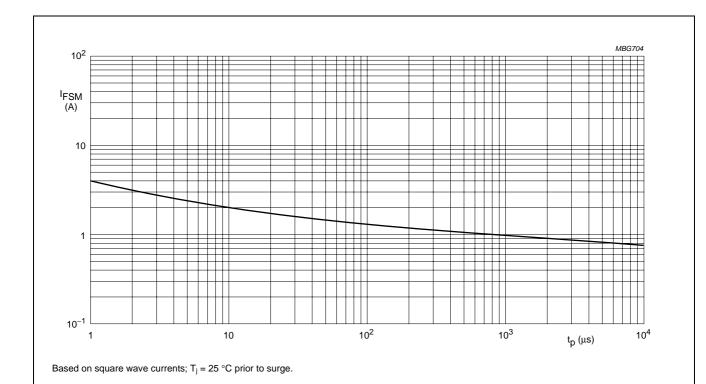


Fig.2 Maximum permissible continuous forward current as a function of ambient temperature.



- (1)  $T_j = 150$  °C; typical values.
- (2)  $T_j = 25$  °C; typical values.
- (3)  $T_j = 25$  °C; maximum values.

Fig.3 Forward current as a function of forward voltage.



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Fig.4 Maximum permissible non-repetitive peak forward current as a function of pulse duration.

## Low-leakage diode

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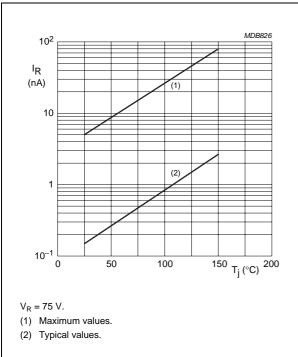
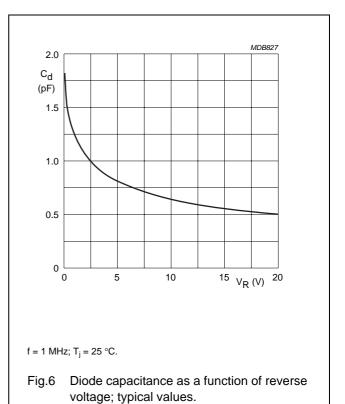
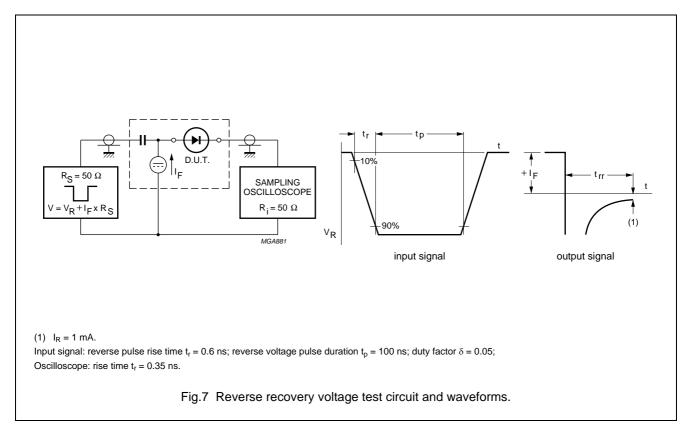


Fig.5 Reverse current as a function of junction temperature.





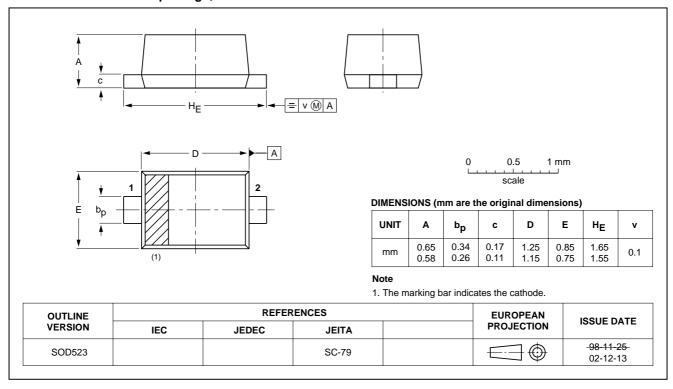
## Low-leakage diode

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#### **PACKAGE OUTLINE**

#### Plastic surface mounted package; 2 leads

SOD523



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## Low-leakage diode

**BAS716** 

#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

#### **Notes**

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#### **Customer notification**

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#### **Contact information**

For additional information please visit: http://www.nxp.com

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